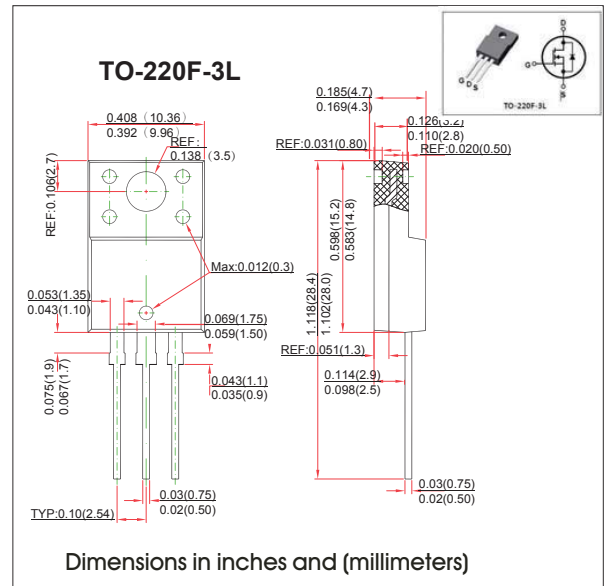


TO-220F-3L Plastic-Encapsulate MOSFETS
Features

- 600V N-Channel Power MOSFET
- $R_{DS(ON)} < 3.6\Omega @ V_{GS} = 10V, I_D = 1.5A$
- Fast switching capability
- Lead free in compliance with EU RoHS directive.
- Improved dv/dt capability, high ruggedness

MECHANICAL DATA

- Case style: TO-220F-3L molded plastic
- Mounting position: any


MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	600	V
Gate-Source Voltage	V_{GSS}	± 30	V
Avalanche Current (Note 2)	I_{AR}	3.0	A
Continuous Drain Current	I_D	3.0	A
Pulsed Drain Current (Note 2)	I_{DM}	12	A
Avalanche Energy Single Pulsed (Note 3)	E_{AS}	200	mJ
Power Dissipation	TO-220/TO-262/TO-263	75	W
	ITO-220	34	W
	TO-251/TO-252	50	W
Junction Temperature	T_J	+150	°C
Operating Temperature	T_{OPR}	-55 ~ +150	°C
Storage Temperature	T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by T_J .

3. $L = 44.4mH, I_{AS}=3A, V_{DD}=50V, R_G=25 \Omega, \text{Starting } T_J = 25^\circ C$

THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/ITO-220 TO-262/TO-263	62.5	°C/W
	TO-251/ TO-252	110	
Junction to Case	TO-220/TO-262/TO-263	1.70	°C/W
	ITO-220	3.70	
	TO-251/ TO-252	2.6	

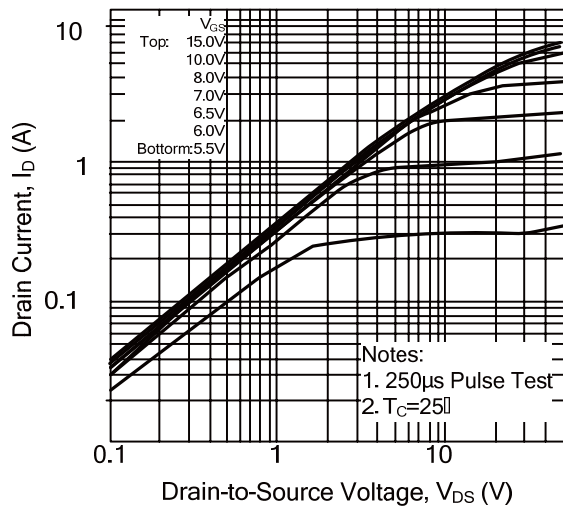
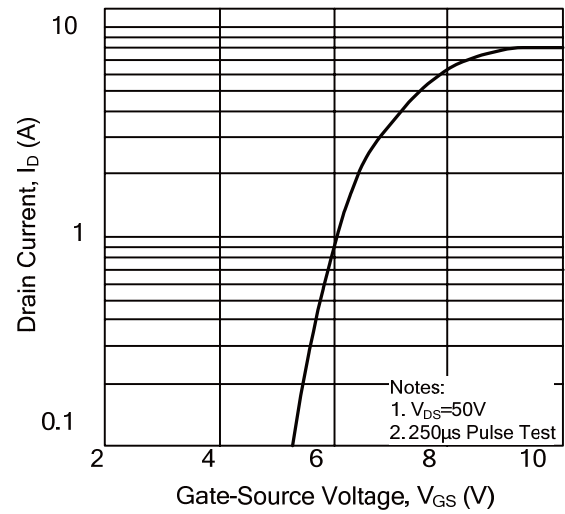
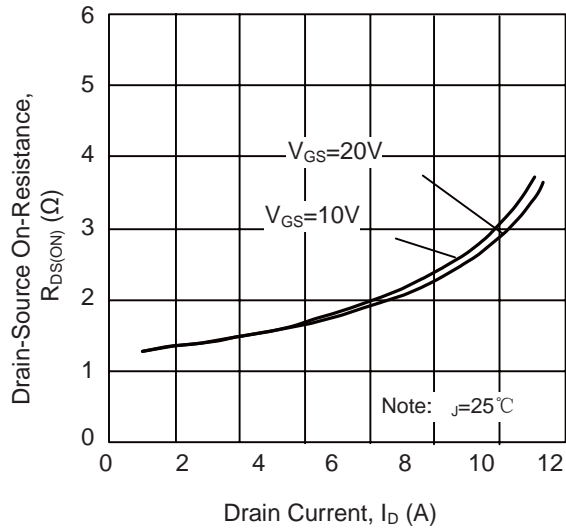
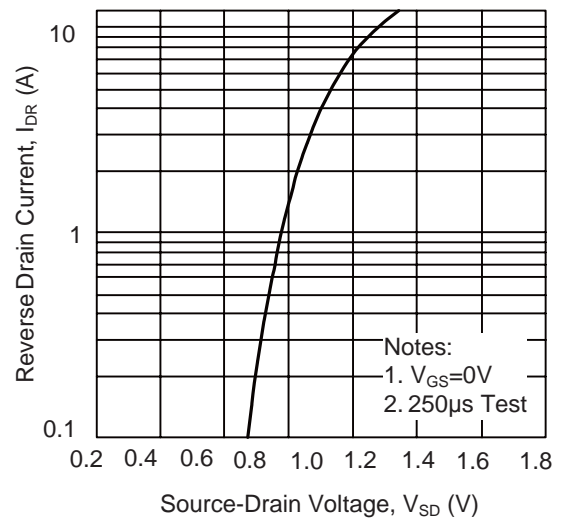
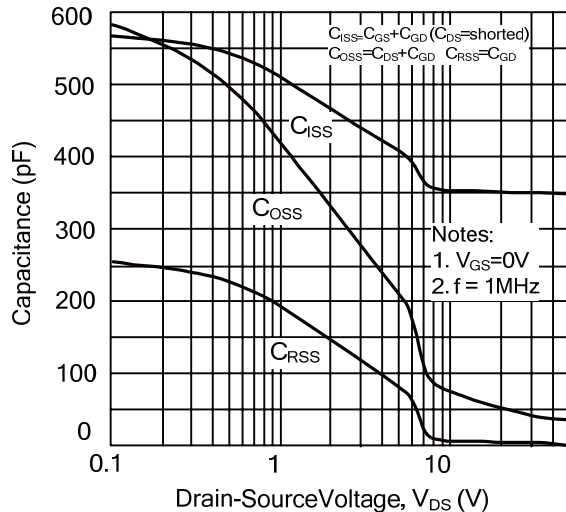
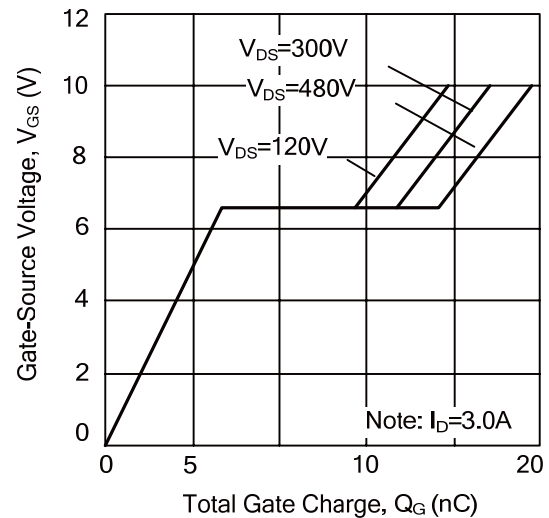
RATINGS AND CHARACTERISTIC CURVES

MOSFET ELECTRICAL CHARACTERISTICS $T_A=25\text{ }^\circ\text{C}$ unless otherwise specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	600			V	
Drain-Source Leakage Current	I_{DSS}	$V_{DS} = 600V, V_{GS} = 0V$			10	μA	
Gate-Source Leakage Current	Forward	I_{GSS}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=1.5A$			3.6	Ω	
DYNAMIC CHARACTERISTICS							
Input Capacitance	C_{ISS}	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1MHz$		350	450	pF	
Output Capacitance	C_{OSS}			50	65	pF	
Reverse Transfer Capacitance	C_{RSS}			5.5	7.5	pF	
SWITCHING CHARACTERISTICS							
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD}=30V, I_D=0.5A,$ $R_G=25\Omega$ (Note 1, 2)		35	50	ns	
Turn-On Rise Time	t_R			60	70	ns	
Turn-Off Delay Time	$t_{D(OFF)}$			100	150	ns	
Turn-Off Fall Time	t_F			65	75	ns	
Total Gate Charge	Q_G	$V_{DS}=50V, I_D=1.3A, I_G=100\mu A$ $V_{GS}=10V$ (Note 1, 2)					
Gate-Source Charge	Q_{GS}			5.2	-	nC	
Gate-Drain Charge	Q_{GD}			4.9	-	nC	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=3.0A$			1	V	
Maximum Continuous Drain-Source Diode Forward Current	I_S				3.0	A	
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				12	A	
Reverse Recovery Time	t_{rr}	$V_{GS} = 0V, I_S = 3A,$ $di_F/dt = 100A/\mu s$ (Note 1)		210		ns	
Reverse Recovery Charge	Q_{RR}			1.2		μC	

Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$
 2. Essentially independent of operating temperature

RATINGS AND CHARACTERISTIC CURVES

On-State Characteristics

Transfer Characteristics

On-Resistance Variation vs. Drain Current and Gate Voltage

On State Current vs. Allowable Case Temperature

Capacitance Characteristics (Non-Repetitive)

Gate Charge Characteristics


RATINGS AND CHARACTERISTIC CURVES

